



**SF-6529**

**B. E. - II (Sem. IV) (IC) Examination**

**May / June - 2011**

**Digital Integrated Circuits**

Time : 3 Hours]

[Total Marks : 100

**Instructions :**

(1)

नीचे दृष्टावेक निशानीवाणी विगतो उत्तरवही पर अवश्य कभवी. Fillup strictly the details of signs on your answer book.	Seat No. :
Name of the Examination :	<input type="text"/>
<input type="text" value="B. E. - 2 (SEM. 4) (IC)"/>	<input type="text"/>
Name of the Subject :	<input type="text"/>
<input type="text" value="DIGITAL INTEGRATED CIRCUITS"/>	<input type="text"/>
Subject Code No. : <input type="text" value="6"/> <input type="text" value="5"/> <input type="text" value="2"/> <input type="text" value="9"/>	<input type="text" value="Student's Signature"/>
Section No. (1, 2,.....) : <input type="text" value="1&amp;2"/>	

- (2) Attempt all questions.
- (3) Figures to the right indicates the marks.
- (4) Assume suitable data whenever necessary.
- (5) Answer to the two sections must be written in separate answer book.

**SECTION - I**

- 1 (a) Attempt any four : 12
  - (i) Explain "FANOUT".
  - (ii) "DTL is faster than TTL". True or False? Justify.
  - (iii) Draw and explain circuit of TTL inverter.
  - (iv) What is a function of diode connected between inputs and Ground in TTL ?
  - (v) Explain term : Saturated Logic and Non Saturated Logic.
- (b) Attempt any two : 8
  - (i) Explain current hogging in DCTL.
  - (ii) Draw and explain basic gate with multi emitter transistor.
  - (iii) Draw and explain fabrication of Schottky transistor.
- 2 (a) Explain Physical Layout of IIL. 7
- (b) Explain Transfer Characteristic of ECL gate. 7

**OR**

- (b) Discuss Manufacturing Specification of RTL gates. 7

- 3 Attempt any two : 16
- (i) Explain in detail Types of TTL Gates.
  - (ii) Define Operating Voltages : VOH, VOL, VIL, VIH.
  - (iii) Explain High threshold DTL Gate.

## SECTION - II

- 4 (a) Answer the following questions : 10
- (i) Give example of SSI and MSI ICs.
  - (ii) Where information can be stored in EPROM Cell ?
  - (iii) What is negative logic gate ?
  - (iv) How the information is stored in six-transistor static cell ?
  - (v) Define : Dynamic memory.
- (b) Discuss fall time in MOS gate. 6
- (c) Discuss average power dissipation and delay power production for CMOS inverter. 4
- 5 (a) Discuss working of EPROM in detail and compare it with EEPROM. 8
- (b) Discuss the organization of a memory for a M-word 3 bit/word memory. 7

### OR

- 5 (a) Discuss the Programmable logic array with proper example. PLA is consisting programmable AND and Programmable OR arrays. 8
- (b) Explain the shift Register with the help of MOS gate. 7
- 6 Answer any three :
- (i) Explain BJT-CMOS interfacing. Why and where does the pull up register require ?
  - (ii) In connection with conventional BICMOS inverter and improve your design with passive to active discharging device.
  - (iii) Discuss the Decoder ROM and A three-word, 5 bit ROM using diode connection between address lines and bit lines.
  - (iv) Compare PMOS and NMOS and write the Active and Saturation Current Equation.
  - (v) Discuss shift register sequential memory.